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Application Number:	10566170			
International Application Number:				
Confirmation Number:	2513			
Title of Invention:	SEMICONDUCTOR FILM MANUFACTURING METHOD AND SUBSTRATE MANUFACTURING METHOD			
First Named Inventor/Applicant Name:	Yoshinobu Sekiguchi			
Customer Number:	5514			
Filer:	Damond Edward Vadnais			
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Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.
1 Foreign Reference	E-value Defenses	TM 550740 - "	3157069		
	TW_558743.pdf	aa6bb6795c7c6a3ac12ace3419l28419 527c4d94	no	93	
Warnings:		_			
Information:					
_	2 NPL Documents	TW_Official_Action.pdf	848529	no	23
2			f74fcc8e2c7585d5f759f276a289e3637 ob650eb		
Warnings:					
Information:					
		1912747			
3	3 Foreign Reference	TW_I284360.pdf	e70c24735elfb9702l0lc7eb1d4aa541b 3322211	no	54
Warnings:					
Information:					
4 NPL Documents	Xiao_Intro_Semiconductor_ Mfg_Tech_2001_p603.pdf	208079	no	2	
		b5769108229481060a6b13f06caca296 18cocte9			
Warnings:					
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5 Information Disclosure Statement (IDS) Filed	IDS_00862_109138.pdf	784408	no	4	
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Warnings:					
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6 Fee Worksheet (PTO-06)	fee-info.pdf	8236	no	2	
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